Bulletin PD-21020 rev. A 07/06

International
IOR Rectifier

MBRB20..CTPbF
MBR20..CT-1PbF

SCHOTTKY RECTIFIER

20 Amp

$I_{F(AV)}$ = 20Amp
V_R = 35/ 45V

Major Ratings and Characteristics

Characteristics		Values	Units
$I_{F(AV)}$	Rectangular waveform (Per Device)	20	A
I_{FRM}	@ T_C = 135°C (PerLeg)	20	A
V_{RRM}		35/45	V
I_{FSM}	@ tp = 5 µs sine	1060	A
V_F	@ 10 Apk, T_J = 125°C	0.57	V
T_J	range	- 65 to 150	°C

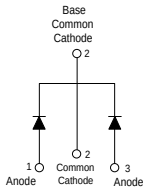
Description/ Features

This center tap Schottky rectifier has been optimized for low reverse leakage at high temperature. The proprietary barrier technology allows for reliable operation up to 150° C junction temperature. Typical applications are in switching power supplies, converters, free-wheeling diodes, and reverse battery protection.

- 150° C T_J operation
- Center tap TO-220 and D^2Pak packages
- Low forward voltage drop
- High purity, high temperature epoxy encapsulation for enhanced mechanical strength and moisture resistance
- High frequency operation
- Guard ring for enhanced ruggedness and long term reliability
- Lead-Free ("PbF" suffix)

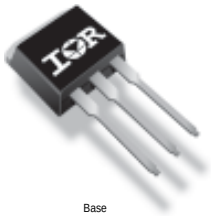
Case Styles

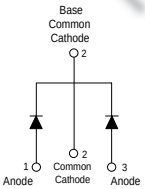
MBRB20..CTPbF



D^2PAK

MBR20..CT-1PbF





TO-262

Voltage Ratings

	Parameters	MBRB2035CT MBR2035CT-1	MBRB2045CT MBR2045CT-1
V_R	Max. DC Reverse Voltage (V)	35	45
V_{RWM}	Max. Working Peak Reverse Voltage (V)		

Absolute Maximum Ratings

	Parameters	Values	Units	Conditions
$I_{F(AV)}$	Max. Average Forward (Per Leg) Current (Per Device)	10 20	A	@ T_C = 135° C, (Rated V_R)
I_{FRM}	Peak Repetitive Forward Current (Per Leg)	20	A	Rated V_R, square wave, 20kHz T_C = 135° C
I_{FSM}	Non Repetitive Peak Surge Current	1060	A	5µs Sine or 3µs Rect. pulse — Following any rated load condition and with rated V_{RRM} applied
		150		Surge applied at rated load conditions halfwave, single phase, 60Hz
E_{AS}	Non-Repetitive Avalanche Energy	8	mJ	(Per Leg) T_J = 25 °C, I_{AS} = 2 Amps, L = 4 mH
I_{AR}	Repetitive Avalanche Current (Per Leg)	2	A	Current decaying linearly to zero in 1 µsec Frequency limited by T_J max. V_A = 1.5 x V_R typical

Electrical Specifications

	Parameters	Values	Units	Conditions	
V_{FM}	Max. Forward Voltage Drop (1)	0.84	V	@ 20A	T_J = 25 °C
		0.57	V	@ 10A	T_J = 125 °C
		0.72	V	@ 20A	
I_{RM}	Max. Instantaneus Reverse Current (1)	0.1	mA	T_J = 25 °C	Rated DC voltage
		15	mA	T_J = 125 °C	
$V_{F(TO)}$	Threshold Voltage	0.354	V	T_J = T_J max.	
r_t	Forward Slope Resistance	17.6	mΩ		
C_T	Max. Junction Capacitance	600	pF	V_R = 5V_{DC} (test signal range 100Khz to 1Mhz) 25°C	
L_S	Typical Series Inductance	8.0	nH	Measured from top of terminal to mounting plane	
dv/dt	Max. Voltage Rate of Change	10000	V/ µs	(Rated V_R)	

(1) Pulse Width < 300µs, Duty Cycle <2%

Thermal-Mechanical Specifications

	Parameters		Values	Units	Conditions
T_J	Max. Junction Temperature Range		-65 to 150	°C	
T_{stg}	Max. Storage Temperature Range		-65 to 175	°C	
R_{thJC}	Max. Thermal Resistance Junction to Case (Per Leg)		2.0	°C/W	DC operation
R_{thCS}	Typical Thermal Resistance Case to Heatsink		0.50	°C/W	Mounting surface, smooth and greased Only for TO-220
wt	Approximate Weight		2 (0.07)	g (oz.)	
T	Mounting Torque	Min.	6 (5)	Kg-cm (lbf-in)	Non-lubricated threads
		Max.	12 (10)		
	Device Marking		MBRB20..CT		Case style D^2Pak
			MBR20..CT-1		Case style TO-262

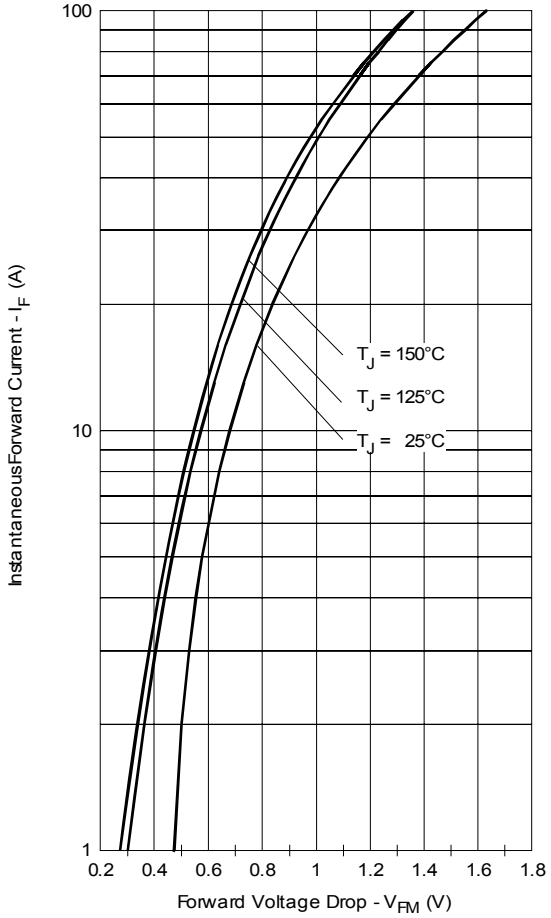


Fig. 1 - Max. Forward Voltage Drop Characteristics (Per Leg)

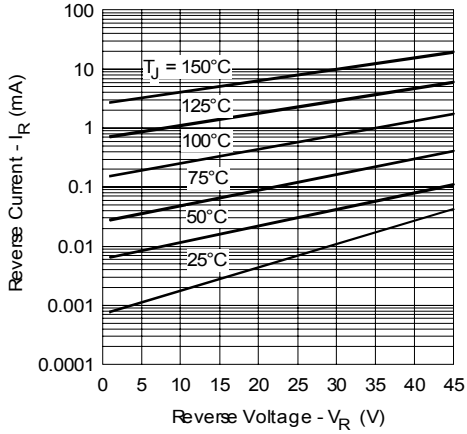


Fig. 2 - Typical Values Of Reverse Current Vs. Reverse Voltage (Per Leg)

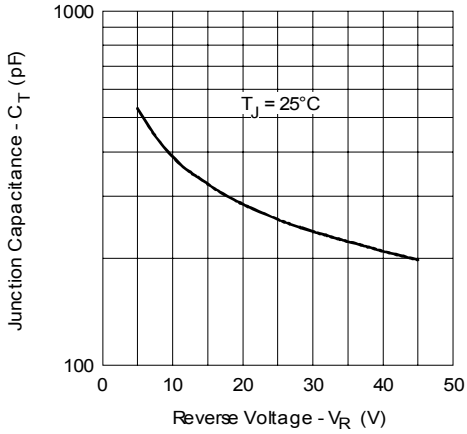


Fig. 3 - Typical Junction Capacitance Vs. Reverse Voltage (Per Leg)

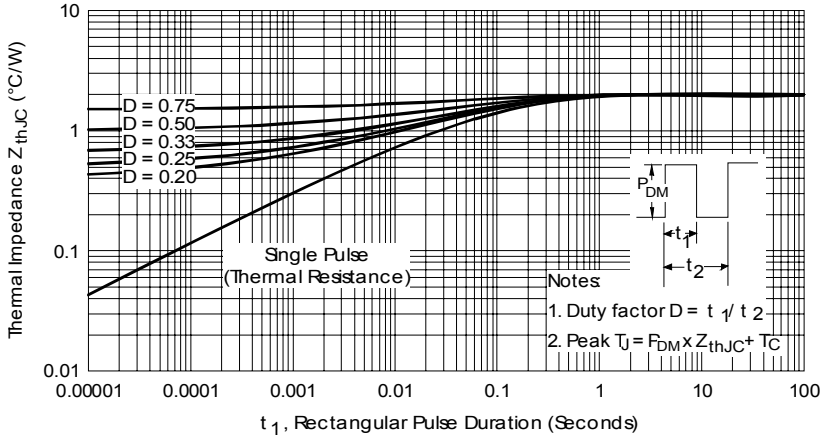


Fig. 4 - Max. Thermal Impedance Z_{thJC} Characteristics (Per Leg)

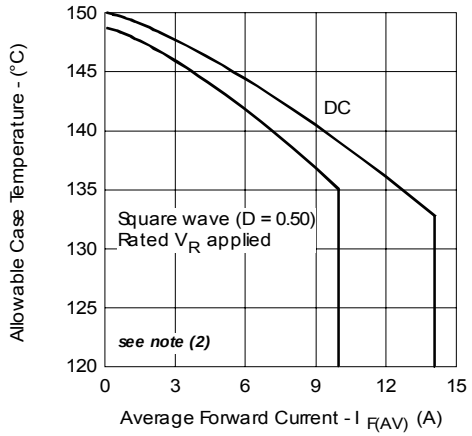


Fig. 5 - Max. Allowable Case Temperature
Vs. Average Forward Current (Per Leg)

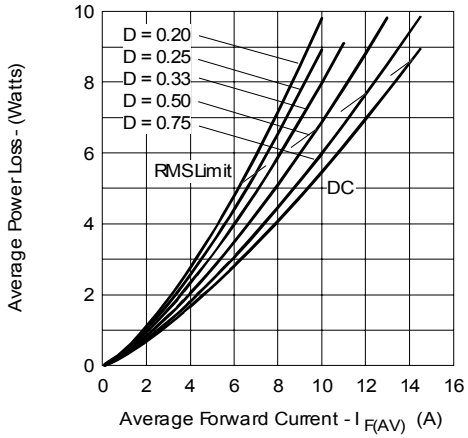


Fig. 6 - Forward Power Loss Characteristics
(Per Leg)

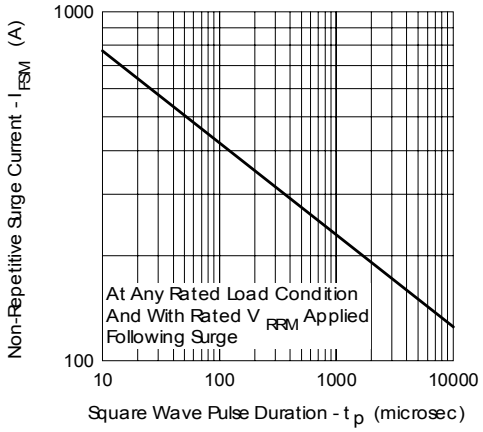
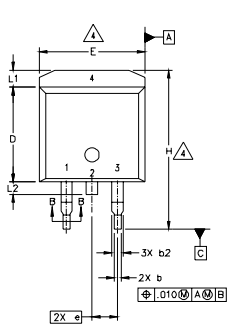
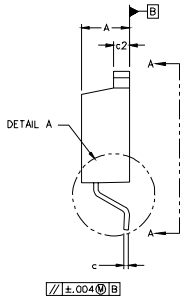


Fig. 7 - Max. Non-Repetitive Surge Current (Per Leg)

(2) Formula used: $T_C = T_J - (Pd + Pd_{REV}) \times R_{thJC}$;
Pd = Forward Power Loss = $I_{F(AV)} \times V_{FM} @ (I_{F(AV)} / D)$ (see Fig. 6);
Pd_{REV} = Inverse Power Loss = $V_{R1} \times I_R (1 - D)$; $I_R @ V_{R1}$ = rated V_R

Outlines Table





NOTES:
1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994
2. DIMENSIONS ARE SHOWN IN MILLIMETERS [INCHES].
3. DIMENSION D & E DO NOT INCLUDE MOLD FLASH. MOLD FLASH SHALL NOT EXCEED 0.127 [.005"] PER SIDE. THESE DIMENSIONS ARE MEASURED AT THE OUTMOST EXTREMES OF THE PLASTIC BODY.
4. DIMENSION b1 AND c1 APPLY TO BASE METAL ONLY.
5. CONTROLLING DIMENSION: INCH.

SYMBOL	DIMENSIONS				NOTES
	MILLIMETERS		INCHES		
	MIN.	MAX.	MIN.	MAX.	
A	4.06	4.83	.160	.190	
A1	0.00	0.254	.000	.010	
b	0.51	0.99	.020	.039	
b1	0.51	0.89	.020	.035	4
b2	1.14	1.78	.045	.070	
c	0.38	0.74	.015	.029	
c1	0.38	0.58	.015	.023	4
c2	1.14	1.65	.045	.065	
D	8.51	9.65	.335	.380	3
D1	6.86		.270		
E	9.65	10.67	.380	.420	3
E1	6.22		.245		
e	2.54 BSC		.100 BSC		
H	14.61	15.88	.575	.625	
L	1.78	2.79	.070	.110	
L1		1.65		.065	
L2	1.27	1.78	.050	.070	
L3	0.25 BSC		.010 BSC		
L4	4.78	5.28	.188	.208	
m	17.78		.700		
m1	8.89		.350		
n	11.43		.450		
o	2.08		.082		
p	3.81		.150		
R	0.51	0.71	.020	.028	
θ	90°	93°	90°	93°	

LEAD ASSIGNMENTS

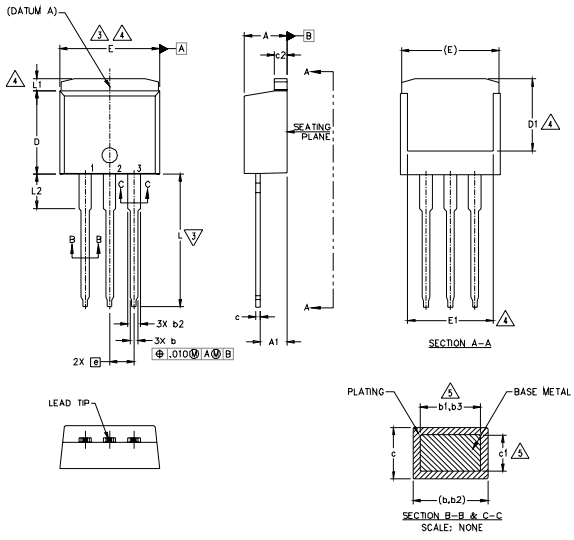
HEXFET
1.- GATE
2, 4.- DRAIN
3.- SOURCE

IGBTs, CoPACK
1.- GATE
2, 4.- COLLECTOR
3.- EMITTER

DIODES
1.- ANODE *
2, 4.- CATHODE
3.- ANODE

* PART DEPENDENT.

Conform to JEDEC outline D^2Pak (SMD-220)
Dimensions in millimeters and (inches)



NOTES:
1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994
2. DIMENSIONS ARE SHOWN IN MILLIMETERS [INCHES].
3. DIMENSION D & E DO NOT INCLUDE MOLD FLASH. MOLD FLASH SHALL NOT EXCEED 0.127 [.005"] PER SIDE. THESE DIMENSIONS ARE MEASURED AT THE OUTMOST EXTREMES OF THE PLASTIC BODY.
4. THERMAL PAD CONTOUR OPTIONAL WITHIN DIMENSION E, L1, D1 & E1.
5. DIMENSION b1 AND c1 APPLY TO BASE METAL ONLY.
6. CONTROLLING DIMENSION: INCH.
7.- OUTLINE CONFORM TO JEDEC TO-262 EXCEPT A1(max.), b(min.) AND D1(min.) WHERE DIMENSIONS DERIVED THE ACTUAL PACKAGE OUTLINE.

SYMBOL	DIMENSIONS				NOTES
	MILLIMETERS		INCHES		
	MIN.	MAX.	MIN.	MAX.	
A	4.06	4.83	.160	.190	
A1	2.03	3.02	.080	.119	
b	0.51	0.99	.020	.039	
b1	0.51	0.89	.020	.035	5
b2	1.14	1.78	.045	.070	
b3	1.14	1.73	.045	.068	5
c	0.38	0.74	.015	.029	
c1	0.38	0.58	.015	.023	5
c2	1.14	1.65	.045	.065	
D	8.38	9.65	.330	.380	3
D1	6.86	–	.270	–	4
E	9.65	10.67	.380	.420	3,4
E1	6.22	–	.245		4
e	2.54 BSC		.100 BSC		
L	13.46	14.10	.530	.555	
L1	–	1.65	–	.065	4
L2	3.56	3.71	.140	.146	

LEAD ASSIGNMENTS

HEXFET
1.- GATE
2.- DRAIN
3.- SOURCE
4.- DRAIN

IGBTs, CoPACK
1.- GATE
2.- COLLECTOR
3.- EMITTER
4.- COLLECTOR

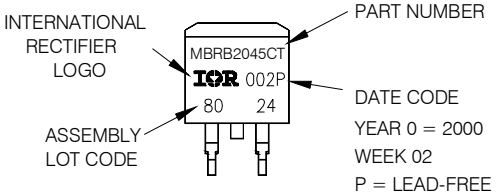
Modified JEDEC outline TO-262
Dimensions in millimeters and (inches)

Part Marking Information

D²PAK

EXAMPLE: THIS IS A MBRB2045CT
LOT CODE 8024
ASSEMBLED ON WW 02, 2000

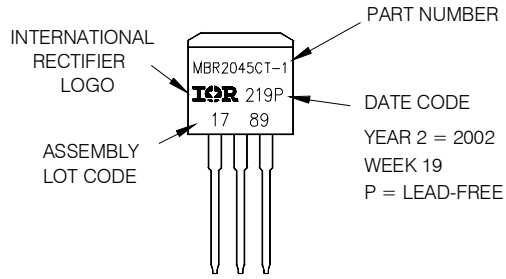
Note: "P" in assembly line position indicates "Lead-Free"



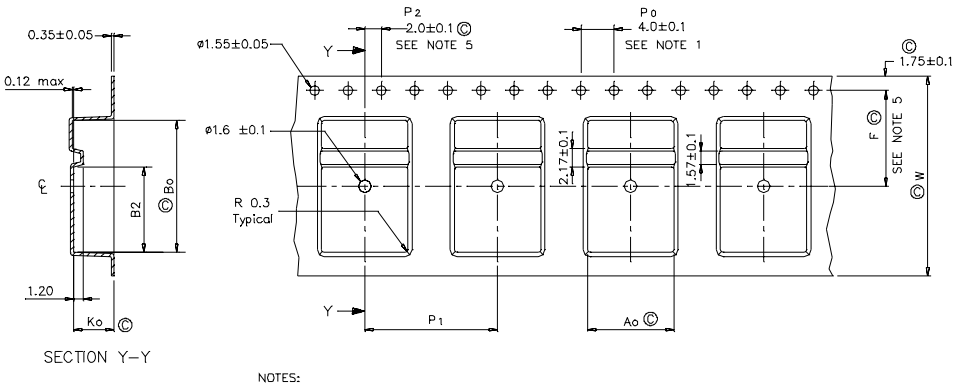
TO-262

EXAMPLE: THIS IS A MBR2045CT-1
LOT CODE 1789
ASSEMBLED ON WW 19, 2002

Note: "P" in assembly line position indicates "Lead-Free"



Tape & Reel Information



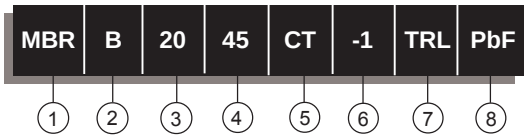
Ao	10.50 +/- 0.1
Bo	15.80 +/- 0.1
B2	10.25 +/- 0.1
Ko	4.90 +/- 0.1
F	11.50 +/- 0.1
P1	16.00 +/- 0.1
W	24.00 +/- 0.3

NOTES:
1.0 10 SPROCKET HOLE PITH CUMULATIVE TOLERANCE ±.02
2.0 CAMBER NOT TO EXCEED 1mm in 100mm
3.0 MATERIAL: CONDUCTIVE BLACK STYRENIC ALLOY
4.0 Ko MEASURED FROM A PLANE ON THE INSIDE BOTTOM OF THE POCKET TO THE TOP SURFACE OF THE CARRIER
5.0 MEASURED FROM CENTRELINE OF SPROCKET HOLE TO CENTRELINE OF POCKET
6.0 VENDOR: (OPTIONAL)
7.0 MUST ALSO MEET REQUIREMENTS OF EIA STANDAR #EIA-481A TAPING OF SURFACE MOUNT COMPONENTS FOR AUTOMATIC PLACEMENT
8.0 SURFACE RESISTIVITY OF MOLDED MATL. MUST MEASURE LESS OR EQUAL TO 10^6 OHMS PER SQUARE. MEASURED IN ACCORDANCE TO PROCEDURE GIVEN IN ASTM D-257 & ASTM D-991
9.0 TOTAL LENGTH PER REEL MUST BE 45 METERS
10.0 © CRITICAL

Dimensions in millimeters and (inches)

Ordering Information Table

Device Code



1	-	Essential Part Number
2	-	B = Surface Mount None = TO-220
3	-	Current Rating (20 = 20A)
4	-	Voltage code: Code = V_{RRM} (35 = 35V, 45 = 45V)
5	-	CT = Essential Part Number
6	-	"-1" = TO-262
7	-	• none = Tube (50 pieces) • TRL = Tape & Reel (Left Oriented - for D^2Pak only) • TRR = Tape & Reel (Right Oriented - for D^2Pak only)
8	-	• none = Standard Production • PbF = Lead-Free

Data and specifications subject to change without notice.
This product has been designed and qualified for Industrial Level and Lead-Free.
Qualification Standards can be found on IR's Web site.

International
IOR Rectifier

IR WORLD HEADQUARTERS: 233 Kansas St., El Segundo, California 90245, USA Tel: (310) 252-7105
TAC Fax: (310) 252-7309
07/06

Notice

The products described herein were acquired by Vishay Intertechnology, Inc., as part of its acquisition of International Rectifier's Power Control Systems (PCS) business, which closed in April 2007. Specifications of the products displayed herein are pending review by Vishay and are subject to the terms and conditions shown below.

Specifications of the products displayed herein are subject to change without notice. Vishay Intertechnology, Inc., or anyone on its behalf, assumes no responsibility or liability for any errors or inaccuracies.

Information contained herein is intended to provide a product description only. No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document. Except as provided in Vishay's terms and conditions of sale for such products, Vishay assumes no liability whatsoever, and disclaims any express or implied warranty, relating to sale and/or use of Vishay products including liability or warranties relating to fitness for a particular purpose, merchantability, or infringement of any patent, copyright, or other intellectual property right.

The products shown herein are not designed for use in medical, life-saving, or life-sustaining applications. Customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Vishay for any damages resulting from such improper use or sale.